Enclosure Heating and Heater Selection

Why Heat an Enclosure?

Today's miniaturization of enclosure components results in high packing densities, which in turn results in higher temperatures within the enclosure. These high temperatures are harmful to electronic components. In response, cooling systems have become standard in many applications. However, just as critical and widely underestimated, are failures caused by the formation of moisture.

Under certain climatic conditions, moisture can build up not only in outdoor or poorly insulated enclosures, but also in highly protected and well-sealed enclosures.

Moisture and Failure

Moisture, especially when combined with aggressive gases and dust, causes atmospheric corrosion and can result in the failure of components such as circuit breakers, busbars, relays, integrated circuit boards and transformers. The greatest danger lies in conditions where electronic equipment is exposed to relatively high air humidity or extreme variations in temperature, such as day-and-night operation or outdoor installation. Failure of components in such cases is usually caused by changing contact resistances, flashovers, creepage currents or reduced insulation properties.

Eliminate Moisture

Moisture and corrosion will remain low if relative air humidity stays below 60%. However, relative humidity above 65% will significantly increase moisture and corrosion problems. This can be prevented by keeping the environment inside an enclosure at a temperature as little as 9°F (5°C) higher than that of the ambient air. Constant temperatures are a necessity to guarantee optimal operating conditions. Continuous temperature changes not only create condensation but they reduce the life expectancy of electronic components significantly. Electronic components can be protected by cooling during the day and heating at night.

Thermal Management

Modern enclosure heaters are designed to protect against condensation. They heat the air inside enclosures, preventing water vapor from condensing on components while providing the greatest possible air circulation and low energy consumption.

Other heating element technology improvements include:

- · Longer operating life
- · Greater energy efficiencies
- · Quick wiring options
- Easier mounting
- Fan heaters should be considered for larger enclosures to ensure that the entire enclosure is heated uniformly

Heater Location

Ideally, most heaters will perform optimally when mounted near the bottom of an enclosure and used in conjunction with a control device, thermostat, and/or hygrostat. The control device may be a separate device, or it may be integral to the heater. With the controller located in an area of the cabinet that is representative of the average temperature or humidity requirement, the heater should then be placed in a position near the bottom of the enclosure. If a separate control device is used, the heater should not be located directly beneath the controller to ensure that the controller is not influenced by direct heat from the heater.

Heater Calculation

Enclosure Dimensions:

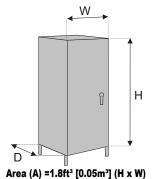
Follow Steps 1-5 to determine the heating requirement of an enclosure (US units - left column, metric - right)

STEP 1: Determine the Surface Area (A) of your enclosure which is exposed to open air.

height =feetmeters
width =feetmeters
depth =feetmeters
Choose Mounting Option from next page, and calculate the surface area as indicated
A = ft2 or m2
STEP 2: Choose the Heat Transmission Coefficient (k) for your enclosure's material of construction.
painted steel = $0.511 \text{ W/(ft2K)} 5.5 \text{ W/(m2K)}$
stainless steel = 0.344 W/(ft2K) 3.7 W/(m2K)
aluminum = 1.115 W/(ft2K) 12 W/(m2K)
plastic or insulatedstainless = 0.325 W/(ft2K) 3.5 W/(m2K)
k =W/(ft2K) or W/(m2K)
STEP 3: Determine the Temperature Differential (ΔT).
A. Desired enclosure interior temp. =oFoC
B. Lowest ambient (outside) temp. =oFoC
Subtract B from A = Temp. diff. $(\Delta T) = _{o}C$
For these calculations, ΔT must be in Kelvin (K). Therefore, divide ΔT (oF) by 1.8. ΔT = K
STEP 4: Determine Heating Power (PV), if any (generated from existing components, i.e. transformer).
PV = W or W
STEP 5: Calculate the Required Heating Power (PH) for your enclosure based on the above values.
If enclosure is located inside:
$PH = (A \times k \times \Delta T) - PV = \underline{\hspace{1cm}} W$
If enclosure is located outside:
$PH = 2 x (A x k x \Delta T) - PV = W$

Enclosure Mounting Types and Surface Area Calculations

1. Free-Standing



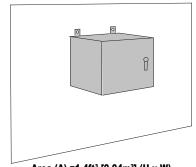
Area (A) =1.8ft³ [0.05m²] (H x W)

+ 1.4 (H x D) +1.8ft3 [0.05m3] (W x D)

Area (A) =1.8ft³ [0.05m³] (H x W) + (H x D) +1.8ft³ [0.05m³] (W x D)

+ 1.8 (H x D) +1.8ft³ [0.05m³] (W x D)

2. Wall-Mounted



Area (A) =1.4ft³ [0.04m³] (H x W)

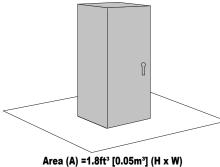
+ 1.4 (H x D) +1.8ft3 [0.05m3] (W x D)

Area (A) =1.4ft³ [0.04m³] (H x W)

+ (H x D) +1.8ft³ [0.05m³] (W x D)

Area (A) =1.4ft³ [0.04m³] (H x W) + 1.8 (H x D) +1.8ft³ [0.05m³] (W x D)

3. Ground

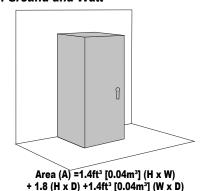


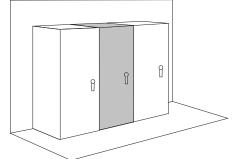
Area (A) =1.8ft³ [0.05m³] (H x W) + 1.8 (H x D) +1.4ft³ [0.04m³] (W x D)

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4. Ground and Wall





Area (A) =1.4ft³ [0.04m³] (H x W) + 1.4 (H x D) +1.4ft³ [0.04m³] (W x D)

Area (A) =1.4ft³ [0.04m³] (H x W) + (H x D) +1.4ft³ [0.04m³] (W x D)

50W to 200W Hazardous Location Heaters





Applications

Compact convection heater of temperature class T3 (392°F/200°C max.) for use in hazardous areas to prevent formation of condensation, temperature fluctuations, and for protection against frost in control and switch cabinets, as well as in measuring equipment.

Features

- For use in hazardous areas
- Large convection surface
- DIN rail and screw mounting
- Ready to use with strain relief
- Maintenance free
- Temperature class T3





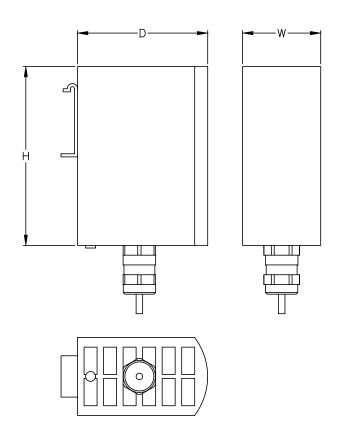
50W to 200W Hazardous Location Heaters Specifications					
Temperature Class	T3				
Ex Protection Type 11 2 GD Gases	Ex db IIC T3 Gb				
Dusts	Ex tb IIIC T200 °C Db IP66				
Ambient Temperature	-76 to 185°F [-60 to 85°C]				
Surface Temperature	Max. 392°F [200°C]				
Heating Element	High performance cartridge				
Heating Body	Aluminum profile, silver anodized				
Connection	Silicone cable (halogen-free) 3 x 18 AWG [0.82 mm²], length 3ft [1m]				
Connection PE	18 to 14 AWG [0.75 to 2.55 mm2]				
Housing	Aluminum, silver anodized				
Mounting	Clip for 35mm DIN rail, EN 60715 for heating body sizes 3.2 x 1.9" and 4.7 x 2.4.0in [103mm]				
Mounting Position	Vertical airflow (connection at bottom)				
Storage Temperature	-76 to +185°F [-60 to 85°C]				
Operating / Storage Humidity	Max. 90% RH (non-condensing)				
Protection Type / Protection Class	IP66 / I (grounded)				
Approvals	EPS 16 ATEX 1109X IECEx EPS 16.0048X EAC, CE 0081 ऒ 11 2 GD				

50W to 200W Hazardous Location Heaters							
Part Number	Price	Operating Voltage	Heating Capacity	Rec. Pre-fuse T (time-delay)	Dimensions	Weight (lb)	
020310-00	\$198.00	AC 230V	50W	0.5 A	4.33 x 1.89 x 3.15[110 x 48 x 80]	1.5	
020319-00	\$198.00	AC 120V	50W	1.0 A	4.33 x 1.89 x 3.15 [110 x 48 x 80]	1.5	
020320-00	\$227.00	AC 230V	100W	1.0 A	7.09 x 1.89 x 3.15 [180 x 48 x 80]	2.2	
020329-00	\$227.00	AC 120V	100W	2.0 A	7.09 x 1.89 x 3.15[180 x 48 x 80]	2.2	
020340-00	\$252.00	AC 230V	200W	2.0 A	9.45 x 2.36 x 4.72 [240 x 60 x 120]		
020349-00	\$252.00	AC 120V	200W	4.0 A	9.45 x 2.36 x 4.72 [240 x 60 x 120]	3.7	
Note: Dimensions in inches [millimeters].							

50W to 200W Hazardous Location Heaters



Dimensions



GENERAL INFORMATION						
PART NUMBER	HEIGHT	DEPTH	WIDTH			
020310-00	4.33 [109.9]	1.89 [48.0]	3.15 [80.0]			
020319-00	4.33 [109.9]	1.89 [48.0]	3.15 [80.0]			
020320-00	7.09 [180.0]	1.89 [48.0]	3.15 [80.0]			
020329-00	7.09 [180.0]	1.89 [48.0]	3.15 [80.0]			
020340-00	9.45 [240.0]	2.36 [59.9]	4.72 [119.8]			
020349-00	9.45 [240.0]	2.36 [59.9]	4.72 [119.8]			